# **Specification Sheet for Approved**

| Customer Name:     |                  |
|--------------------|------------------|
| Customer Part No.: |                  |
| Ceaiya Part No:    | MTC201210 Series |
| Spec No:           | T2012            |

## **[** For Customer Approval Only **]**

| If you | Approval, | Please | Stamp |
|--------|-----------|--------|-------|
| ,      |           |        |       |

## **[** RoHS Compliant Parts **]**

| Approved By | Checked By | Prepared By |  |
|-------------|------------|-------------|--|
| 李庆辉         | 刘志坚        | 劳水笼         |  |

# Shenzhen Ceaiya Electronics Co., Ltd.

地址 1: 深圳市龙华区观澜街道银星智界一期综合楼 716 号

地址 2: 广东省东莞清溪镇青滨东路 105 号力合紫荆智能制造中心 10 栋

Http://www.szceaiya.com Tel: 0769-89135516 Fax: 0769-89135519

# [Version of Changed Record]

| Rev. | Effective Date | Changed Contents | Change Reasons | Approved By |
|------|----------------|------------------|----------------|-------------|
| A0   | 2022-07-13     | New release      | I              | Li qing hui |
|      |                |                  |                |             |
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## 1. Scope

This specification applies to the MTC201210 Series of wire wound SMD power inductor.

### 2. Product Description and Identification (Part Number)

1) Description:

MTC201210 series of Wire wound SMD power inductor.

2) Product Identification (Part Number)

| <u>MTC</u> | <u>201210</u> | - | <u>R47</u> | <u>M</u> | <u>T</u> |
|------------|---------------|---|------------|----------|----------|
| 1          | 2             |   | 3          | 4        | (5)      |

| 1)  | Туре                            |
|-----|---------------------------------|
| MTC | Mini Molded Chip Power Inductor |

| ③ Nominal Inductance |         |  |  |
|----------------------|---------|--|--|
| Example              | Example |  |  |
| R47                  | 0.47uH  |  |  |
| 100                  | 10uH    |  |  |
| 101                  | 100uH   |  |  |

| (5) | Packing              |
|-----|----------------------|
| Т   | Tape Carrier Package |

| 2   | ② External Dimensions(L×W×H) |             |  |  |
|-----|------------------------------|-------------|--|--|
| 201 | 210                          | 2.0×1.2×1.0 |  |  |

| ④ Inductance Tolerance |            |  |  |
|------------------------|------------|--|--|
| N                      | $\pm 30\%$ |  |  |
| M                      | ±20%       |  |  |

#### 3. Electrical Characteristics

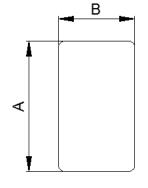
Please refer to Item 5.

- 1) Operating temperature range (individual chip without packing):  $-40^{\circ}$ C ~ +125 $^{\circ}$ C (Including Self-heating)
- 2) Storage temperature range (packaging conditions): -10°C ~ +40°C and RH 70% (Max.).

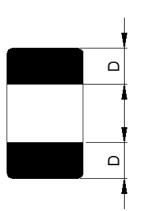
### 4. Shape and Dimensions (Unit:mm)

Dimensions and recommended PCB pattern for reflow soldering, please see Fig4-1 and Table4-1

## **Shape and Dimensions:**







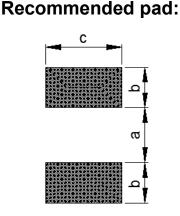


Table 4-1.

Fig4-1.

| Α       | В       | С      | D        | а       | b       | С       |
|---------|---------|--------|----------|---------|---------|---------|
| 2.0±0.2 | 1.2±0.2 | 1.0Max | 0.60±0.2 | 0.8~1.2 | 0.8~1.2 | 1.2~2.0 |

### 5. Electrical Characteristics

| Part Number     | Inductance | DC<br>Resistance |       | Saturation<br>Current |      | Heat Rating<br>Current |      |
|-----------------|------------|------------------|-------|-----------------------|------|------------------------|------|
|                 | 1MHz/1V    | Max.             | Тур.  | Max.                  | Тур. | Max.                   | Тур. |
| Units           | uH         | Ω                | Ω     | Α                     | Α    | Α                      | Α    |
| Symbol          | L          | DCR              |       | Isat                  |      | Irms                   |      |
| MTC201210-R47MT | 0.47±20%   | 0.032            | 0.027 | 4.50                  | 5.00 | 4.00                   | 4.30 |
| MTC201210-R68MT | 0.68±20%   | 0.046            | 0.038 | 3.60                  | 4.30 | 3.00                   | 3.50 |
| MTC201210-1R0MT | 1.0±20%    | 0.056            | 0.046 | 3.40                  | 3.80 | 2.90                   | 3.30 |
| MTC201210-2R2MT | 2.2±20%    | 0.166            | 0.140 | 2.00                  | 2.20 | 1.50                   | 1.70 |

Note: 1: Rated current: Isat(max.) or Irms(max.), whichever is smaller;

\*2: Saturation Current: Max. Value, DC current at which the inductance drops less than 30% from its value without current; Typ. Value, DC current at which the inductance drops 30% from its value without current;

3: Irms: DC current that causes the temperature rise ( $\Delta$ T) from 20°C ambient.

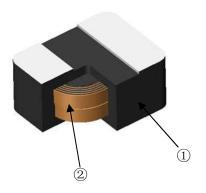
For Max. Value,  $\triangle T < 40^{\circ}C$ ; for Typ. Value,  $\triangle T$  is approximate  $40^{\circ}C$ .

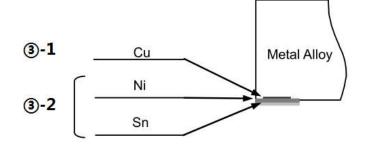
The part temperature (ambient + temp. rise) should not exceed 125°C under worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

¾4:Absolute maximum voltage:DC 20V

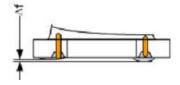
#### 6. Structure

The structure of MTC201210 product.





| NO. | Components | Material                                 |  |  |
|-----|------------|--|--|--|
| 1   | Core       | Soft magnetic Metal                      |  |  |
| 2   | Wire       | Polyurethane system enameled copper wire |  |  |
| ③-1 |            | Inside Cu                                |  |  |
| ③-2 | Electrodes | Ni+Sn Plating Chemicals                  |  |  |



△f: Clearance between terminal and the surface of plate must be 0.12mm max when coil is placed on a flat plate.

# 7. Reliability Test

| Items                      | Requirements                                     | Test Methods and Remarks   |  |  |  |  |
|----------------------------|--|--|--|--|--|--|
| 7.1<br>Bonding<br>Strength |  | It shall be soldered on the substrate. Applying Force(F): 10N Hold Duration: 5s                                |  |  |  |  |
|                            |  |  |  |  |  |  |
| 7.2                        | Chip coil shall not be damaged.                  | Substrate: Glass-epoxy substrate   |  |  |  |  |
| Bending<br>Strength        | l p i i i i i i i i i i i i i i i i i i          | (100×40×1.0mm) Speed of Applying Force: 0.5mm / s  |  |  |  |  |
| ou ongui                   |  |  |  |  |  |  |
|                            |  | Deflection: 2mm  Hold Duration: 20s  Pressing device   |  |  |  |  |
|                            |  |  |  |  |  |  |
|                            |  | ↓  加圧治具  |  |  |  |  |
|                            |  | R340   |  |  |  |  |
|                            |  | 新科 □ Specimen  |  |  |  |  |
|                            |  | 4562 4562  |  |  |  |  |
| 7.3                        | No visible mechanical damage.                    | Solder the inductor to the testing jig (glass epoxy  |  |  |  |  |
| Vibration                  | Inductance change: Within ±10%                   | board) using eutectic solder.  |  |  |  |  |
| Vibration                  | Cu pad Solder mask                               | 2) The inductor shall be subjected to a simple harmonic  |  |  |  |  |
|                            | Solder Mask                                      | motion having total amplitude of 1.5mm, the frequency  |  |  |  |  |
|                            |  | being varied uniformly between the approximate limits of 10 and 55Hz.  |  |  |  |  |
|                            |  | 3) The frequency range from 10 to 55Hz and return to   |  |  |  |  |
|                            |  | 10Hz shall be traversed in approximately 1 minute. this  |  |  |  |  |
| Class France Board         |  | motion shall be applied for a period of 2 hours in each 3mutually perpendicular directions (total of 6 hours). |  |  |  |  |
|                            | Glass Epoxy Board                                | , , ,  |  |  |  |  |
| 7.4<br>Solderability       | The wetting area of the electrode shall          | Flux:Ethanol solution of rosin,25(wt)%   |  |  |  |  |
|                            | be at least 90% covered with new solder coating. | Solder: Sn-3.0Ag-0.5Cu Pre-Heating:150±10°C / 60 to 90s  |  |  |  |  |
|                            | Colder coating.                                  | Solder Temperature:245±5°C   |  |  |  |  |
|                            |  | Immersion Time:3 s   |  |  |  |  |
| 7.5                        | Appearance:No damage                             | Reflow soldering method  |  |  |  |  |
| Resistance to              | Inductance Change: within ±10%                   | Flux: Ethanol solution of rosin,25(wt)%  |  |  |  |  |
| Soldering                  |  | Solder: Sn-3.0Ag-0.5Cu   |  |  |  |  |
| Heat                       |  | Pre-Heating: 150 to 180°C / 60 to 120s   |  |  |  |  |
|                            |  | Solder Temperature: 230°C min. / 20 to 40s   |  |  |  |  |
|                            |  | Peak Temperature: 250+5/-0°C   |  |  |  |  |
|                            |  | Reflow times: 2 times max  |  |  |  |  |
|                            |  | Test board shall be 0.8 mm thick. Base material shall  |  |  |  |  |
|                            |  | be glass epoxy resin.  |  |  |  |  |
|                            |  | Then measured after exposure Standard atmospheric  |  |  |  |  |
|                            |  | conditions for 1~2h.   |  |  |  |  |

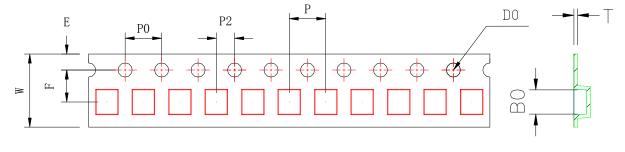
# Specification Sheet for SMD Power Inductor

# 7. Reliability Test

| Items                     | Requirements                    | Test Methods and Remarks   |   |  |  |  |     |
|---------------------------|---------------------------------|--|---|--|--|--|-----|
| 7.6                       |                                 | Temperature: 125±2°C   |   |  |  |  |     |
| Heat                      |                                 | Time: 500h (±12h)  |   |  |  |  |     |
| Resistance                |                                 | Then measured after exposure Standard atmospheric conditions for 1~2h. |   |  |  |  |     |
| 7.7<br>Cold<br>Resistance | Appearance:No damage            | Temperature: -40±2°C Time: 500h (±12h)                                 |   |  |  |  |     |
| resistance                |                                 | Then measured after exposure Standard atmosphe conditions for 1~2h.    |   |  |  |  |     |
| 7.8                       |                                 | Temperature: 40±2°C  |   |  |  |  |     |
| Humidity                  | Inductance Change : within ±10% | Humidity: 90 to 95%(RH) Time: 500h (±12h) Then measured after          |   |  |  |  |     |
| riamianty                 |                                 |  |   |  |  |  |     |
|                           |                                 |  |   |  |  |  | 7.9 |
| Temperature               |                                 |  | 1 step: -40±2°C / 30±3m 2 step: Ordinary temp. / 3m max. 3 step: +125±2°C / 30±3m |  |  |  |     |
| Cycle                     |                                 |  |   |  |  |  |     |
|                           |                                 |  |   |  |  |  |     |
|                           |                                 | 4 step: Ordinary temp. / 3m max.                                       |   |  |  |  |     |
|                           |                                 | Total of 100 cycles  |   |  |  |  |     |
|                           |                                 | Then measured after exposure Standard atmospheric                      |   |  |  |  |     |
|                           |                                 | conditions for 1~2h.   |   |  |  |  |     |

## 8. Packaging and Marking:

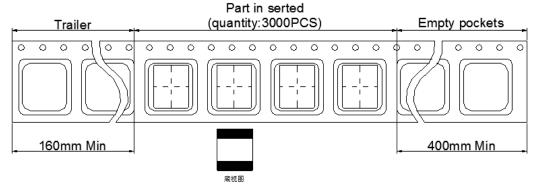
### 8-1. Carrier Tape Dimensions:





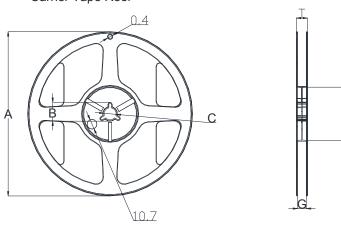
| ITEM | W    | A0   | В0   | K0   | Р    | F    | Е    | D0   | P0   | P2   | Т     |
|------|------|------|------|------|------|------|------|------|------|------|-------|
| DIM  | 8.00 | 1.3  | 2.3  | 1.10 | 4.00 | 3.5  | 1.75 | 1.50 | 4.00 | 2.00 | 0.20  |
| TOLE | ±0.3 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | +0.1 | ±0.1 | ±0.1 | ±0.05 |

## 8-2. Taping Dimensions:



### 8-3.Reel Dimensions:

Carrier Tape Reel



| Type | Α   | В        | С      | G | N  | Т    |
|------|-----|----------|--------|---|----|------|
| 8mm  | 178 | 20.7±0.8 | 13±0.4 | 9 | 60 | 10.8 |

## 8-4. Packaging Quantity:

3KPCS/ Reel

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